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# 1. General description

The HEF4014B is a fully synchronous edge-triggered 8-bit static shift register with eight synchronous parallel inputs (D0 to D7), a synchronous serial data input (DS), a synchronous parallel enable input (PE), a LOW-to-HIGH edge-triggered clock input (CP) and buffered parallel outputs from the last three stages (Q5 to Q7).

Operation is synchronous and the device is edge-triggered on the LOW-to-HIGH transition of CP. Each register stage is of a D-type master-slave flip-flop type. When PE is HIGH, data is loaded into the register from D0 to D7 on the LOW-to-HIGH transition of CP. When PE is LOW, data is shifted to the first position from DS, and all the data in the register is shifted one position to the right on the LOW-to-HIGH transition of CP. The clock input's Schmitt trigger action makes it highly tolerant of slower clock rise and fall times.

It operates over a recommended  $V_{DD}$  power supply range of 3 V to 15 V referenced to  $V_{SS}$  (usually ground). Unused inputs must be connected to  $V_{DD}$ ,  $V_{SS}$ , or another input.

# 2. Features and benefits

- Tolerant of slow clock rise and fall times
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from –40 °C to +85 °C
- Complies with JEDEC standard JESD 13-B

# 3. Applications

- Parallel-to-serial converter
- Serial data queueing
- General purpose register

# 4. Ordering information

#### Table 1.Ordering information

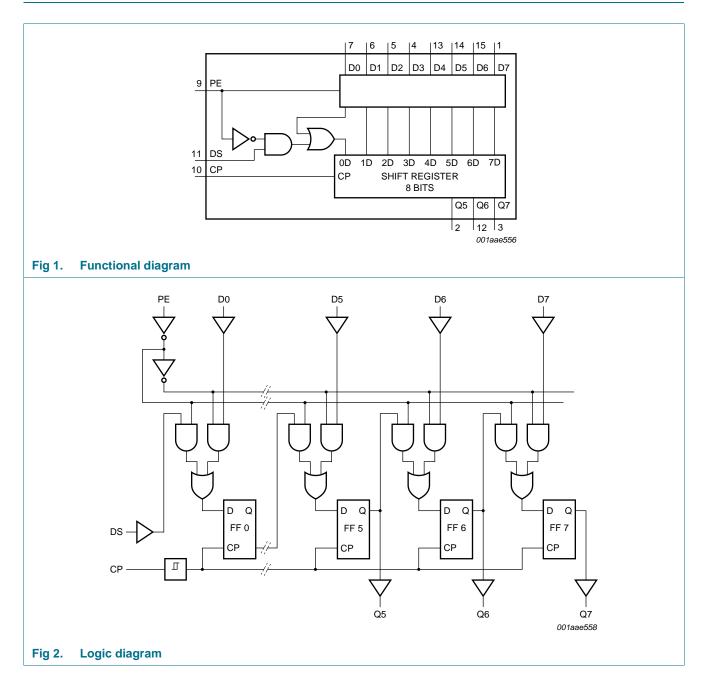
All types operate from -40 °C to +85 °C

| Type number | Package |  |          |
|-------------|---------|--|----------|
|             | Name    | Description  | Version  |
| HEF4014BP   | DIP16   | plastic dual in-line package; 16-leads (300 mil)           | SOT38-4  |
| HEF4014BT   | SO16    | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |



8-bit static shift register

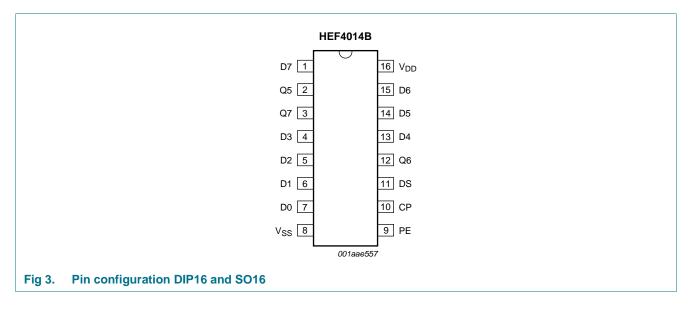
# 5. Functional diagram



HEF4014B

# 6. Pinning information

# 6.1 Pinning



# 6.2 Pin description

| Table 2.        | Pin description           |  |
|-----------------|---------------------------|--|
| Symbol          | Pin                       | Description                              |
| Q5 to Q7        | 2, 12, 3                  | output                                   |
| D0 to D7        | 7, 6, 5, 4, 13, 14, 15, 1 | parallel data input                      |
| V <sub>SS</sub> | 8                         | ground supply voltage                    |
| PE              | 9                         | parallel enable input                    |
| CP              | 10                        | clock input (LOW-to-HIGH edge-triggered) |
| DS              | 11                        | serial data input                        |
| V <sub>DD</sub> | 16                        | supply voltage                           |
| -               |                           |  |

# 7. Functional description

| Number of clock    | Inputs       |    |    | Outputs   | Outputs   |           |  |
|--------------------|--------------|----|----|-----------|-----------|-----------|--|
| transitions        | СР           | DS | PE | Q5        | Q6        | Q7        |  |
| Serial operation   |              | l  |    |           |           |           |  |
| 1                  | $\uparrow$   | 1D | L  | Х         | Х         | Х         |  |
| 2                  | $\uparrow$   | 2D | L  | Х         | Х         | Х         |  |
| 3                  | $\uparrow$   | 3D | L  | Х         | Х         | Х         |  |
| 6                  | $\uparrow$   | Х  | L  | 1D        | Х         | Х         |  |
| 7                  | $\uparrow$   | Х  | L  | 2D        | 1D        | Х         |  |
| 8                  | $\uparrow$   | Х  | L  | 3D        | 2D        | 1D        |  |
|                    | $\downarrow$ | Х  | Х  | no change | no change | no change |  |
| Parallel operation |              |    |    |           |           |           |  |
| 1                  | $\uparrow$   | Х  | Н  | D5        | D6        | D7        |  |
|                    | $\downarrow$ | Х  | Х  | no change | no change | no change |  |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; nD = HIGH or LOW;  $\uparrow = LOW$ -to-HIGH clock transition;  $\downarrow = HIGH$ -to-LOW clock transition;

# 8. Limiting values

#### Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter               | Conditions   | Min          | Max                   | Unit |
|------------------|-------------------------|--|--------------|-----------------------|------|
| V <sub>DD</sub>  | supply voltage          |  | -0.5         | +18                   | V    |
| I <sub>IK</sub>  | input clamping current  | $V_{I}$ < -0.5 V or $V_{I}$ > $V_{DD}$ + 0.5 V             | -            | ±10                   | mA   |
| VI               | input voltage           |  | -0.5         | V <sub>DD</sub> + 0.5 | V    |
| Ι <sub>ΟΚ</sub>  | output clamping current | $V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm DD}$ + 0.5 V | -            | ±10                   | mA   |
| I <sub>I/O</sub> | input/output current    |  | -            | ±10                   | mA   |
| I <sub>DD</sub>  | supply current          |  | -            | 50                    | mA   |
| T <sub>stg</sub> | storage temperature     |  | -65          | +150                  | °C   |
| T <sub>amb</sub> | ambient temperature     |  | -40          | +85                   | °C   |
| P <sub>tot</sub> | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$         |              |                       |      |
|                  |                         | DIP16 package  | <u>[1]</u> _ | 750                   | mW   |
|                  |                         | SO16 package   | [2]          | 500                   | mW   |
| Р                | power dissipation       | per output   | -            | 100                   | mW   |

[1] For DIP16 package: Ptot derates linearly with 12 mW/K above 70 °C.

[2] For SO16 package: P<sub>tot</sub> derates linearly with 8 mW/K above 70 °C.

# 9. Recommended operating conditions

| Recommended operating conditions    |  |   |  |  |   |
|-------------------------------------|--|---|--|--|---|
| Parameter                           | Conditions   | Min   | Тур  | Max  | Unit  |
| supply voltage                      |  | 3   | -  | 15   | V   |
| input voltage                       |  | 0   | -  | $V_{DD}$   | V   |
| ambient temperature                 | in free air  | -40   | -  | +85  | °C  |
| input transition rise and fall rate | $V_{DD} = 5 V$   | -   | -  | 3.75   | μs/V  |
|                                     | V <sub>DD</sub> = 10 V   | -   | -  | 0.5  | μs/V  |
|                                     | V <sub>DD</sub> = 15 V   | -   | -  | 0.08   | μs/V  |
|                                     | Parameter         supply voltage         input voltage         ambient temperature | supply voltageinput voltageambient temperaturein free airinput transition rise and fall rate $V_{DD} = 5 V$ $V_{DD} = 10 V$ | ParameterConditionsMinsupply voltage3input voltage0ambient temperaturein free air-40input transition rise and fall rate $V_{DD} = 5 V$ - $V_{DD} = 10 V$ - | ParameterConditionsMinTypsupply voltage3-input voltage0-ambient temperaturein free air-40-input transition rise and fall rate $V_{DD} = 5 V$ $V_{DD} = 10 V$ | ParameterConditionsMinTypMaxsupply voltage3-15input voltage0- $V_{DD}$ ambient temperaturein free air-40-+85input transition rise and fall rate $V_{DD} = 5 V$ 3.75 $V_{DD} = 10 V$ 0.5 |

# **10. Static characteristics**

#### Table 6. Static characteristics

 $V_{SS} = 0$  V;  $V_I = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

| Symbol                       | Parameter                    | Conditions              | V <sub>DD</sub> | T <sub>amb</sub> = -40 °C |       | T <sub>amb</sub> = +25 °C |       | T <sub>amb</sub> = +85 °C |       | Unit |
|------------------------------|------------------------------|-------------------------|-----------------|---------------------------|-------|---------------------------|-------|---------------------------|-------|------|
|                              |                              |                         |                 | Min                       | Max   | Min                       | Max   | Min                       | Max   |      |
| /IH HIGH-level input voltage |                              | I <sub>O</sub>   < 1 μA | 5 V             | 3.5                       | -     | 3.5                       | -     | 3.5                       | -     | V    |
|                              |                              |                         | 10 V            | 7.0                       | -     | 7.0                       | -     | 7.0                       | -     | V    |
|                              |                              |                         | 15 V            | 11.0                      | -     | 11.0                      | -     | 11.0                      | -     | V    |
| VIL                          | LOW-level input voltage      | $ I_O  < 1 \ \mu A$     | 5 V             | -                         | 1.5   | -                         | 1.5   | -                         | 1.5   | V    |
|                              |                              |                         | 10 V            | -                         | 3.0   | -                         | 3.0   | -                         | 3.0   | V    |
|                              |                              |                         | 15 V            | -                         | 4.0   | -                         | 4.0   | -                         | 4.0   | V    |
| V <sub>OH</sub>              | HIGH-level output voltage    | $ I_O  < 1 \ \mu A$     | 5 V             | 4.95                      | -     | 4.95                      | -     | 4.95                      | -     | V    |
|                              |                              |                         | 10 V            | 9.95                      | -     | 9.95                      | -     | 9.95                      | -     | V    |
|                              |                              |                         | 15 V            | 14.95                     | -     | 14.95                     | -     | 14.95                     | -     | V    |
| V <sub>OL</sub>              | CoL LOW-level output voltage | I <sub>O</sub>   < 1 μA | 5 V             | -                         | 0.05  | -                         | 0.05  | -                         | 0.05  | V    |
|                              |                              | 10 V                    | -               | 0.05                      | -     | 0.05                      | -     | 0.05                      | V     |      |
|                              |                              |                         | 15 V            | -                         | 0.05  | -                         | 0.05  | -                         | 0.05  | V    |
| он                           | HIGH-level output current    | $V_{O} = 2.5 V$         | 5 V             | -                         | -1.7  | -                         | -1.4  | -                         | -1.1  | mA   |
|                              |                              | $V_{O} = 4.6 V$         | 5 V             | -                         | -0.52 | -                         | -0.44 | -                         | -0.36 | mA   |
|                              |                              | V <sub>O</sub> = 9.5 V  | 10 V            | -                         | -1.3  | -                         | -1.1  | -                         | -0.9  | mA   |
|                              |                              | V <sub>O</sub> = 13.5 V | 15 V            | -                         | -3.6  | -                         | -3.0  | -                         | -2.4  | mA   |
| OL                           | LOW-level output current     | $V_{O} = 0.4 V$         | 5 V             | 0.52                      | -     | 0.44                      | -     | 0.36                      | -     | mA   |
|                              |                              | $V_{O} = 0.5 V$         | 10 V            | 1.3                       | -     | 1.1                       | -     | 0.9                       | -     | mA   |
|                              |                              | V <sub>O</sub> = 1.5 V  | 15 V            | 3.6                       | -     | 3.0                       | -     | 2.4                       | -     | mA   |
| <b> </b>                     | input leakage current        |                         | 15 V            | -                         | ±0.3  | -                         | ±0.3  | -                         | ±1.0  | μΑ   |
| DD                           | supply current               | $I_{O} = 0 A$           | 5 V             | -                         | 20    | -                         | 20    | -                         | 150   | μΑ   |
|                              |                              |                         | 10 V            | -                         | 40    | -                         | 40    | -                         | 300   | μΑ   |
|                              |                              |                         | 15 V            | -                         | 80    | -                         | 80    | -                         | 600   | μΑ   |
| CI                           | input capacitance            |                         | -               | -                         | -     | -                         | 7.5   | -                         | -     | pF   |

# **11. Dynamic characteristics**

### Table 7. Dynamic characteristics

 $T_{amb} = 25 \ ^{\circ}C; V_{SS} = 0 V.$ 

| Symbol                | Parameter         | Conditions           | $V_{DD}$ | Extrapolation formula <sup>[1]</sup> | Min | Тур | Max | Unit |
|-----------------------|-------------------|----------------------|----------|--------------------------------------|-----|-----|-----|------|
| t <sub>PHL</sub>      | HIGH to LOW       | CP to Qn;            | 5 V      | 103 ns + (0.55 ns/pF)C <sub>L</sub>  | -   | 130 | 260 | ns   |
|                       | propagation delay | see Figure 4         | 10 V     | 44 ns + (0.23 ns/pF)C <sub>L</sub>   | -   | 55  | 110 | ns   |
|                       |                   |                      | 15 V     | 32 ns + (0.16 ns/pF)C <sub>L</sub>   | -   | 40  | 80  | ns   |
| t <sub>PLH</sub>      | LOW to HIGH       | CP to Qn;            | 5 V      | 88 ns + (0.55 ns/pF)C <sub>L</sub>   | -   | 115 | 230 | ns   |
|                       | propagation delay | see Figure 4         | 10 V     | 39 ns + (0.23 ns/pF)C <sub>L</sub>   | -   | 50  | 100 | ns   |
|                       |                   |                      | 15 V     | 32 ns + (0.16 ns/pF)C <sub>L</sub>   | -   | 40  | 80  | ns   |
| t <sub>t</sub>        | transition time   | Qn output;           | 5 V      | 2 10 ns + (1.00 ns/pF)C <sub>L</sub> | -   | 60  | 120 | ns   |
|                       |                   | see Figure 4         | 10 V     | 9 ns + (0.42 ns/pF)C <sub>L</sub>    | -   | 30  | 60  | ns   |
|                       |                   |                      | 15 V     | 6 ns + (0.28 ns/pF)C <sub>L</sub>    | -   | 20  | 40  | ns   |
| tw                    | pulse width       | CP input;            | 5 V      |                                      | 70  | 35  | -   | ns   |
|                       |                   | minimum width;       | 10 V     |                                      | 30  | 15  | -   | ns   |
|                       |                   | see <u>Figure 5</u>  | 15 V     |                                      | 24  | 12  | -   | ns   |
| t <sub>su</sub>       | set-up time       | $PE \rightarrow CP;$ | 5 V      |                                      | 40  | 10  | -   | ns   |
|                       |                   | see <u>Figure 5</u>  | 10 V     |                                      | 25  | 5   | -   | ns   |
|                       |                   |                      | 15 V     |                                      | 15  | 0   | -   | ns   |
|                       | $DS\toCP;$        | 5 V                  |          | +35                                  | -5  | -   | ns  |      |
|                       |                   | see Figure 5         | 10 V     |                                      | +25 | -5  | -   | ns   |
|                       |                   |                      | 15 V     |                                      | 25  | 0   | -   | ns   |
|                       |                   | $Dn\toCP;$           | 5 V      |                                      | +35 | -5  | -   | ns   |
|                       |                   | see Figure 5         | 10 V     |                                      | +25 | -5  | -   | ns   |
|                       |                   |                      | 15 V     |                                      | 25  | 0   | -   | ns   |
| t <sub>h</sub>        | hold time         | $PE \rightarrow CP;$ | 5 V      |                                      | +25 | -5  | -   | ns   |
|                       |                   | see Figure 5         | 10 V     |                                      | 20  | 0   | -   | ns   |
|                       |                   |                      | 15 V     |                                      | 15  | 0   | -   | ns   |
|                       |                   | $DS\toCP;$           | 5 V      |                                      | 30  | 15  | -   | ns   |
|                       |                   | see Figure 5         | 10 V     |                                      | 20  | 10  | -   | ns   |
|                       |                   |                      | 15 V     |                                      | 15  | 7   | -   | ns   |
|                       |                   | $Dn \rightarrow CP;$ | 5 V      |                                      | 30  | 15  | -   | ns   |
|                       |                   | see Figure 5         | 10 V     |                                      | 20  | 10  | -   | ns   |
|                       |                   |                      | 15 V     |                                      | 15  | 7   | -   | ns   |
| f <sub>clk(max)</sub> | maximum clock     | see Figure 5         | 5 V      |                                      | 6   | 13  | -   | MH   |
|                       | frequency         |                      | 10 V     |                                      | 15  | 30  | -   | MH   |
|                       |                   |                      | 15 V     |                                      | 20  | 40  | -   | MH:  |

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C<sub>L</sub> in pF).

[2]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .

HEF4014B Product data sheet

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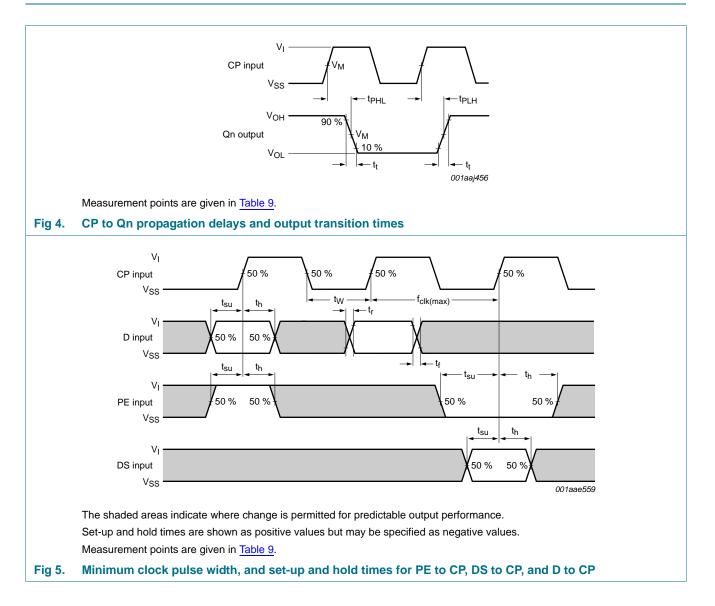
# **HEF4014B**

8-bit static shift register

|             | calculated from the |  | shown. $V_{SS} = 0$ V; $t_r = t_f \le 20$ ns; $T_{amb} = 2$     | 5 °C.  |
|-------------|---------------------|--|---|--|
| Symbol      | Parameter           | $V_{DD}$   | Typical formula for $P_D$ ( $\mu$ W)                            | Where:   |
| PD          | dynamic power       | 5 V  | $P_D = 900 \times f_i + \Sigma(f_o \times C_L) \times V_DD{}^2$ | f <sub>i</sub> = input frequency in MHz;           |
| dissipation | 10 V                | $P_D = 4300 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$ | $f_o = output frequency in MHz;$                                |  |
|             |                     | 15 V   | $P_D = 12000 \times f_i + \Sigma(f_o \times C_L) \times V_DD^2$ | $C_L$ = output load capacitance in pF;             |
|             |                     |  |   | V <sub>DD</sub> = supply voltage in V;             |
|             |                     |  |   | $\Sigma(C_{L} \times f_{o})$ = sum of the outputs. |

#### Table 8. Dynamic power dissipation P<sub>D</sub>

12. Waveforms



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# HEF4014B

# 8-bit static shift register

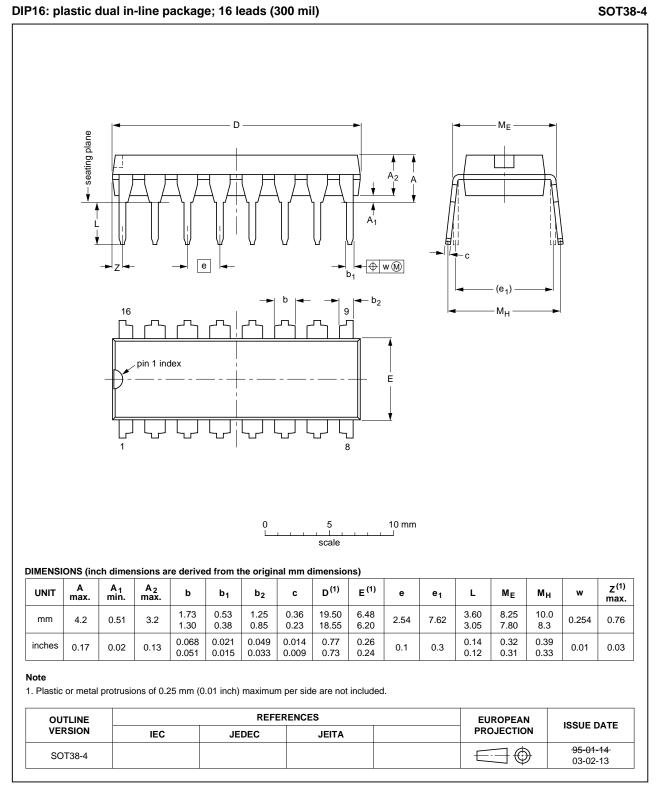
| Table 9.         Measurement points     |   |                    |
|---|---|--------------------|
| Supply voltage                          | Input   | Output             |
| V <sub>DD</sub>                         | V <sub>M</sub>  | V <sub>M</sub>     |
| 5 V to 15 V                             | 0.5V <sub>DD</sub>  | 0.5V <sub>DD</sub> |
|   |   |                    |
|   |   | ,                  |
| Test data is given in <u>Table 10</u> ; |   |                    |
| Definitions for test circuit:           |   |                    |
| DUT = Device Under Test.                |   |                    |
| $C_L$ = load capacitance including jig  | and probe capacitance.                                    |                    |
| $R_T$ = termination resistance should   | be equal to the output impedance $Z_{\text{o}}$ of the pu | se generator.      |
| Fig 6. Test circuit                     |   |                    |

#### Table 10. Test data

| Supply voltage  | Input                              |                                 | Load  |
|-----------------|------------------------------------|---------------------------------|-------|
| V <sub>DD</sub> | VI                                 | t <sub>r</sub> , t <sub>f</sub> | CL    |
| 5 V to 15 V     | V <sub>SS</sub> or V <sub>DD</sub> | ≤ 20 ns                         | 50 pF |

8-bit static shift register

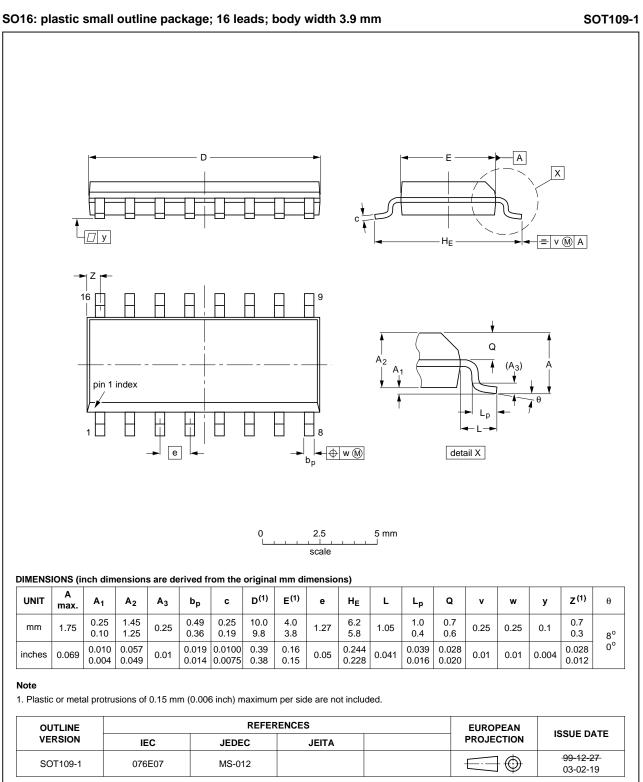
# 13. Package outline



#### Fig 7. Package outline SOT38-4 (DIP16)

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#### Fig 8. Package outline SOT109-1 (SO16)

HEF4014B

# 14. Revision history

| Table 11. Revision h | istory                          |                             |                         |                  |
|----------------------|---------------------------------|-----------------------------|-------------------------|------------------|
| Document ID          | Release date                    | Data sheet status           | Change notice           | Supersedes       |
| HEF4014B v.8         | 20111121                        | Product data sheet          | -                       | HEF4014B v.7     |
| Modifications:       | <ul> <li>Legal pages</li> </ul> | s updated.                  |                         |                  |
|                      | <ul> <li>Changes in</li> </ul>  | "General description" and " | Features and benefits". |                  |
| HEF4014B v.7         | 20110914                        | Product data sheet          | -                       | HEF4014B v.6     |
| HEF4014B v.6         | 20091102                        | Product data sheet          | -                       | HEF4014B v.5     |
| HEF4014B v.5         | 20090624                        | Product data sheet          | -                       | HEF4014B v.4     |
| HEF4014B v.4         | 20090122                        | Product data sheet          | -                       | HEF4014B_CNV v.3 |
| HEF4014B_CNV v.3     | 19950101                        | Product specification       | -                       | HEF4014B_CNV v.2 |
| HEF4014B_CNV v.2     | 19950101                        | Product specification       | -                       | -                |
|                      |                                 |                             |                         |                  |

# **15. Legal information**

#### 15.1 Data sheet status

| Document status[1][2]          | Product status <sup>[3]</sup> | Definition  |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet   | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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#### 8-bit static shift register

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